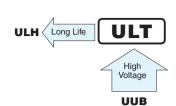


Chip Type, High Voltage. High Temperature Range.

- For SMD Long Life
- Chip type, high voltage and high temperature range.
- Load life of 2000 hours at +125°C.
- Applicable to automatic mounting machine using carrier tape.
- Compliant to the RoHS directive (2011/65/EU).

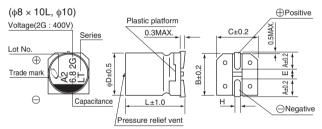




■Specifications

Specifications												
Item	Performance Characteristics											
Category Temperature Range	-40 to +125°C											
Rated Voltage Range	160 to 500V											
Rated Capacitance Range	1.8 to 33µF											
Capacitance Tolerance	±20% at 120Hz, 20°	С										
	Rated voltage (V) 160~450								500			
Leakage Current	- 0.04CV+100(μA)max.(1 minute's)							CV+200(μ.	A)max	(1 minute's)		
			Meası	urem	ent freque	ency : 120	Hz at 20°0					
Tangent of loss angle (tan δ)	Rated voltage (V)	160	200		250	400	450	500				
	tan δ (MAX.)	0.20	0.20		0.25	0.25	0.30	0.30				
	Measurement frequency : 120Hz											
Stability at Low Temperature	Rated voltage (V)		1	160 200		250	400	450	500			
	Impedance ratio ZT / Z20 (MAX.)	40°C / Z+2	0°C	6	6	10	10	15	15			
Endurance	The specifications listed at right shall be met when the capacitors are restored to 20°C after the rated voltage is applied for 2000 hours at 125°C.						tan δ 300% or less the			Within ±30% of the sum	n the intial specif	ied value
Shelf Life	After storing the capacitors under no load at 125°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.											
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the characteristic requirements listed at right when they are removed from the plate.					tan δ Less t			Within ±10% of the Less than or equipment Less than or equ	al to the initial sp	ecified value	
Marking	Black print on the ca	se top.										

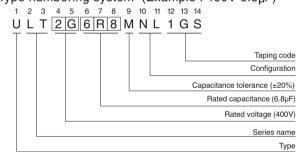
■Chip Type



			(mm)
ØD×L	8×10	10×10	10 × 13.5
Α	2.9	3.2	3.2
В	8.3	10.3	10.3
С	8.3	10.3	10.3
E	3.1	4.5	4.5
L	10	10	13.5
Н	0.8 to 1.1	0.8 to 1.1	0.8 to 1.1

Voltage						
V	160	200	250	400	450	500
Code	2C	2D	2E	2G	2W	2H

Type numbering system (Example : 400V $6.8 \mu F$)



Dimensions

	V	16	60	200		250		400	400		450		500	
Cap.(µF)	Code	2	С	2D		2E		2G		2W		2H		
1.8	1R8		l I									8×10	20	
3.3	3R3		!	!		!				8×10	20	10×10	35	
3.9	3R9		i	i		i		8×10	30	i		i		
4.7	4R7		l I									10 × 13.5	40	
5.6	5R6		į .							10×10	35	!		
6.8	6R8		İ					10×10	45			i		
7.5	7R5		l							10 × 13.5	40			
8.2	8R2		i			8×10	30					i		
10	100		l					10 × 13.5	50			i		
12	120		1	8×10	45			1						
15	150	8 × 10	45	i		10×10	45			i		i		
18	180		i I	10×10	60	10 × 13.5	50							
22	220	10×10	¦ 60											
27	270		i	10 × 13.5	65	i		i i		i		Case size	Rated	
33	330	10 × 13.5	65									$\phi D \times L (mm)$	ripple	

Rated ripple current (mArms) at 125°C 120Hz

• Frequency coefficient of rated ripple current

	-,					
Frequenc	/ 50) Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficien	t C).70	1.00	1.17	1.36	1.50

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please refer to page 3 for the minimum order quantity.